

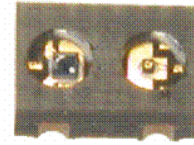
Miniature SMD Reflective Sensor

OPR5005



Features:

- High temperature operation
- Surface mountable
- Compact size
- Excellent ambient light protection



Description:

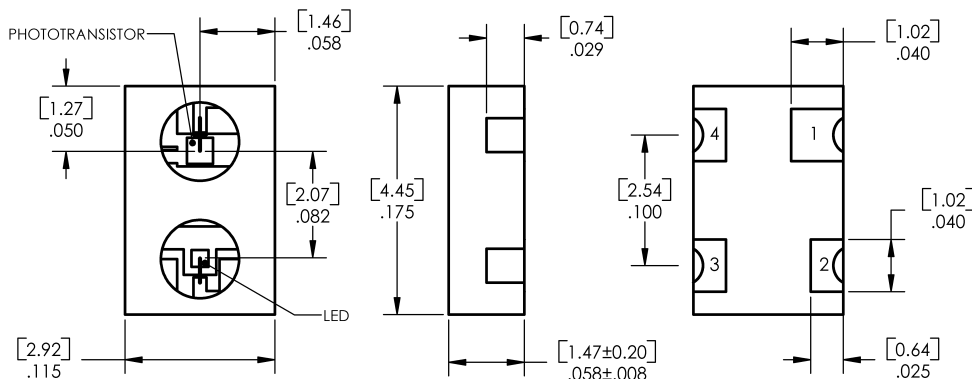
The **OPR5005** is a miniature reflective sensor that combines a silicon phototransistor with a GaAlAs LED in a high-temperature opaque polyamide chip carrier. It is designed to sense the motion or proximity of diffuse reflective surfaces in space-limited applications. The opaque package insures very low cross-talk and shields the phototransistor from ambient light sources, while the silicone encapsulated package allows operation over a wide temperature range. The gold-plated wraparound solder pads offer exceptional storage and wetting characteristics.

See Application Bulletin 237 for handling instructions.

Applications:

- Motion sensors
- Space-limited applications
- Applications requiring ambient light protection
- Can be stored in dirty

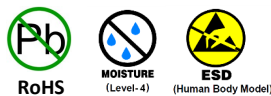
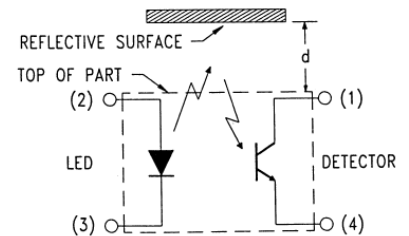
Ordering Information							
Reflective Switch Part Number	LED Peak Wavelength	Sensor	# of Elements	I _{C(ON)} (μA) Min	I _F (mA) Typ / Max	V _{CE} Typ / Max	Packaging
OPR5005	890 nm	Phototransistor	2	725	20 / 50	5 / 30	Chip Tray



TOLERANCE IS ± .005 [0.13]
DIMENSIONS ARE IN INCHES AND [MILLIMETERS].

Warning: Front Windows are pressure sensitive. Do not apply pressure or high vacuum to window.

Pin #	Description
1	Collector
2	Anode
3	Cathode
4	Emitter



General Note
TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

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www.optekinc.com | www.ttelectronics.com

Electrical Specifications

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)	
Storage and Operating Temperature	-55°C to +125°C
Solder reflow time within 5°C of peak temperature is 20 to 40 seconds ⁽¹⁾	250°C
LED	
Forward DC Current	50 mA
Peak Forward Current (1 μs pulse; .03% duty cycle)	1.0 A
Reverse DC Voltage	2.0 V
Power Dissipation ⁽²⁾	75 mW
Phototransistor	
Collector-Emitter Voltage	30 V
Emitter-Collector Voltage	5.0 V
Collector DC Current	25 mA
Power Dissipation ⁽²⁾	75 mW

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS
LED						
V_F	Forward Voltage	-	-	1.7	V	$I_F = 20\text{ mA}$
I_R	Reverse Current	-	-	100	μA	$V_R = 2.0\text{ V}$
Phototransistor						
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	30	-	-	V	$I_C = 100\ \mu\text{A}$
$V_{(BR)ECO}$	Emitter-Collector Breakdown Voltage	5	-	-	V	$I_E = 100\ \mu\text{A}$
I_{CEO}	Collector Dark Current	-	-	100	nA	$V_{CE} = 5.0\text{ V}, I_F = 0,$ $E_e = \leq 0.10\ \mu\text{W}/\text{cm}^2$
Combined						
$I_{C(ON)}$	On-State Collector Current ⁽⁴⁾	725	-	-	μA	$V_{CE} = 5.0\text{ V}, I_F = 20\text{ mA},$ $d = 0.050'' (1.27\text{ mm})$ ⁽³⁾
$V_{CE(SAT)}$	Collector-Emitter Saturation Voltage ⁽⁴⁾	-	-	0.4	V	$I_F = 20\text{ mA}, I_C = 100\ \mu\text{A},$ $d = 0.050'' (1.27\text{ mm})$ ⁽³⁾
I_{CX}	Crosstalk ⁽⁵⁾	-	-	75	μA	$I_F = 20\text{ mA}, V_{CE} = 5\text{ V}$

Notes:

- (1) Solder time less than 5 seconds at temperature extreme.
- (2) Derate linearly 0.75 mW/°C above 25°C.
- (3) Distance from the assembly face to the reflective surface is "d".
- (4) Measured using Eastman Kodak neutral white test card with 90% white diffuse reflectance as a reflecting surface.
- (5) Crosstalk (I_{CX}) is the collector current measured using the indicated current and using a Munsell N2.25 black test card against the face of the part.

General Note

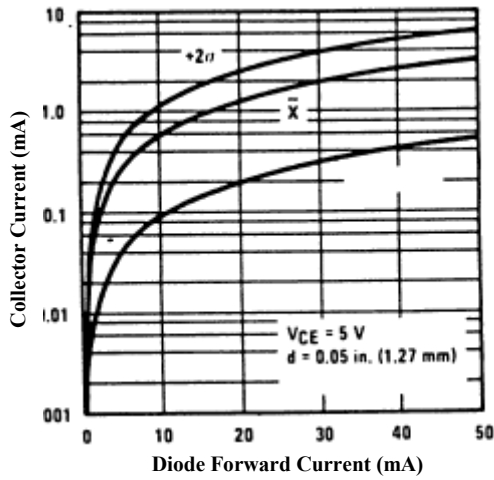
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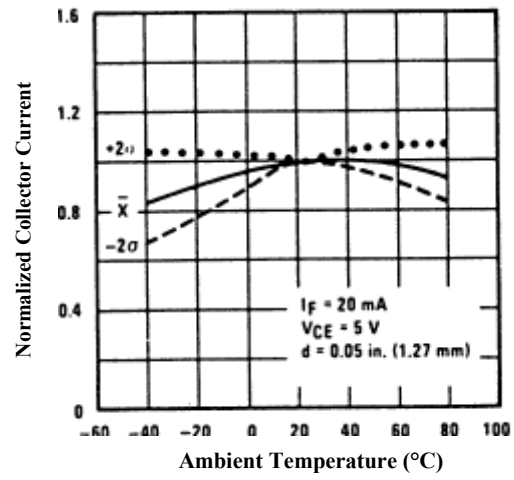
Performance

OPR5005

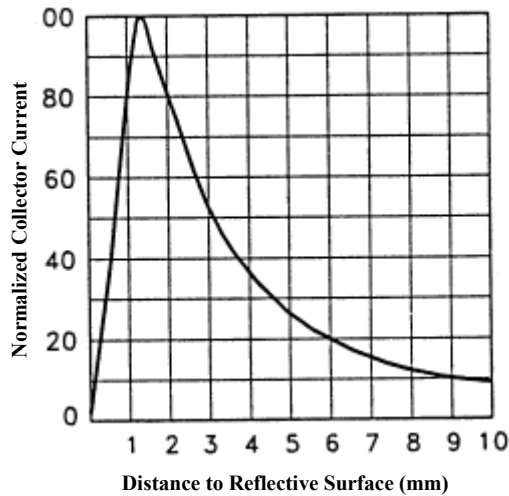
Collector Current vs Diode Forward



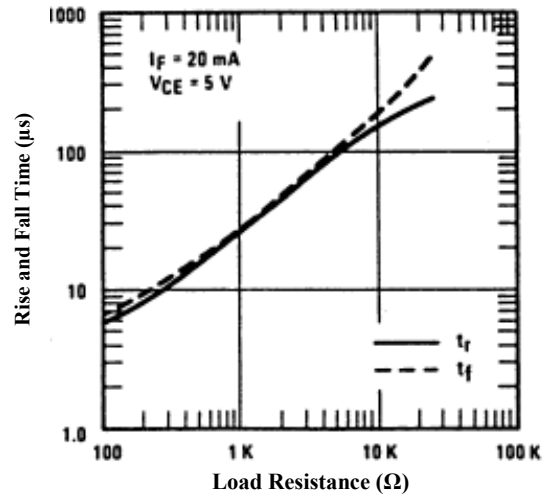
Normalized Collector Current vs



Normalized Collector Current vs



Rise and Fall Time vs Load



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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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